tehnotzka

https://tehnoteka.rs

Informacije o proizvodu (EN)

HP laptop 255 G9 Win 11 Pro (6S6F7EA)



Tehnoteka je online destinacija za upoređivanje cena i karakteristika bele tehnike, potrošačke elektronike i IT uređaja kod trgovinskih lanaca i internet prodavnica u Srbiji. Naša stranica vam omogućava da istražite najnovije informacije, detaljne karakteristike i konkurentne cene proizvoda.

Posetite nas i uživajte u ekskluzivnom iskustvu pametne kupovine klikom na link:

https://tehnoteka.rs/p/hp-laptop-255-g9-win-11-pro-6s6f7ea-akcija-cena/

Overview

HP 255 15.6 inch G9 Notebook PC



Left

- 1. Internal Dual Digital Microphone
- 2. Webcam LED
- 3. Webcam
- 4. Touchpad
- 5. Touchpad Buttons
- 6. Audio Combo Jack
- 1. SuperSpeed USB 20Gbps is not available.

- 7. Power Indicator LED
- 8. Hard Drive Indicator LED
- SuperSpeed USB Type-C[®] 5Gbps signaling rate¹ (Data Transfer Only)
- 10. HDMI Port (Cable Sold Separately)
- 11. RJ-45 / Ethernet Port
- **12.** Power Button



Overview



Right

Power Connector 1.

- 4. SD Card slot
- SuperSpeed USB Type-A 5Gbps signaling rate¹ port **5.** Fingerprint Reader (Selected Models)
- 2. (USB 3.2 Gen 1)
- 3. SuperSpeed USB Type-A 5Gbps signaling rate¹ port (USB 3.2 Gen 1)
- 1. SuperSpeed USB 20Gbps is not available.



QuickSpecs

Overview

AT A GLANCE

- Preinstalled with Windows 11 Pro, Windows Home or FreeDOS
- Choice of powerful AMD Ryzen[™] APU processors
- Choice of 39.62 cm (15.6") diagonal HD and Ultra Wide Viewing Angle FHD 300 nit display
- Fast and dual channel DDR4 SODIMM memory up to 32 GB
- Optimize your video calls with an HD camera and temporal noise reduction that adjusts the lighting to your environment.
- Enhanced security features including discrete TPM 2.0 (select model) and optional Fingerprint reader
- Weight with basic configurations starting at 3.84 lb / 1.74 kg
- Choice of Solid State Drives up to 1 TB, Hard Drive up to 1 TB and optional dual storage support.
- Support wireless options for connectivity on the go including gigabit-speed up to Wi-Fi® 6
- Supports fast charging (50% in 45 minutes) with no impact on battery recharge cycles
- Battery Life up to 10 hours 15 mins
- Full size, optional backlit keyboard and clickpad with Precision Touchpad Supported certified
- AMD FreeSync[™] makes FHD display stutter, input lag, and screen tears ancient history
- Passed 13 MIL-STD test

NOTE: See important legal disclosures for all listed specs in their respective features sections.

PRODUCT NAME

HP 255 15.6 inch G9 Notebook PC

OPERATING SYSTEM

Preinstalled Windows 11 Pro¹

Windows 11 Pro Education¹ Windows 11 Home – HP recommends Windows 11 Pro for business ¹ Windows 11 Home Single Language – HP recommends Windows 11 Pro for business ^{1,2} Windows 11 Home Education – HP recommends Windows 11 Pro for business ¹ FreeDOS

1. Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows is automatically updated and enabled. High speed internet and Microsoft account required. ISP fees may apply and additional requirements may apply over time for updates. See http://www.windows.com.

2. This computer is preinstalled with Windows 11 Home Single Language.

PROCESSORS

AMD Ryzen[™] 7 5825U APU with Radeon[™] (2.00 GHz base frequency, up to Standard, 16 MB L3 cache, 8 cores) ^{3,4,5} AMD Ryzen[™] 5 5625U APU with Radeon[™] (2.30 GHz base frequency, up to Standard, 16 MB L3 cache, 6 cores) ^{3,4,5} AMD Ryzen[™] 3 5425U APU with Radeon[™] (2.70 GHz base frequency, up to Standard, 8 MB L3 cache, 4 cores) ^{3,4,5}

Processor Family

AMD Ryzen[™] 7 Mobile Processors ⁶ AMD Ryzen[™] 5 Mobile Processors ⁶ AMD Ryzen[™] 3 Mobile Processors ⁶

Processor speed denotes maximum performance mode; processors will run at lower speeds in battery optimization mode.
 Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. AMD's numbering is not a measurement of clock speed.

5. AMD Max Boost clock frequency performance varies depending on hardware, software and overall system configuration.
 6. In accordance with Microsoft's support policy, HP does not support the Windows 8 or Windows 7 operating system on products configured with Intel and AMD 7th generation and forward processors or provide any Windows 8 or Windows 7 drivers on http://www.support.hp.com.

CHIPSET

Chipset is integrated with processor.



GRAPHICS

Integrated

AMD Radeon™ Graphics

Supports

Support HD decode, DX12, HDMI 1.4b⁷

7. HD content required to view HD images.

DISPLAY

Non-Touch

39.6 cm (15.6") diagonal, FHD (1920 x 1080), Low Blue Light, anti-glare, UWVA, micro-edge, 300 nits, sRGB 100% eDP 1.4+PSR2 ^{7,8,9}

39.6 cm (15.6") diagonal, FHD (1920 x 1080), anti-glare, SVA, micro-edge, 250 nits, 45% NTSC eDP 1.2 ^{7,8,9} 39.6 cm (15.6") diagonal, FHD (1920 x 1080), anti-glare, UWVA, micro-edge, 250 nits, 45% NTSC eDP 1.2 ^{7,8,9} 39.6 cm (15.6") diagonal, HD (1366x768), anti-glare, SVA, micro-edge, 250 nits, 45% NTSC eDP 1.2 ^{7,8,9}

HDMI

Port supports resolutions up to 1920 x 1080 external resolution @60 Hz

Display Size 15.6" diagonal 39.6 cm (15.6") diagonal

7. HD content required to view HD images.

8. Sold separately or as an optional feature.

9. Resolutions are dependent upon monitor capability, and resolution and color depth settings.

STORAGE AND DRIVES

Primary Storage

1 TB 5400 rpm SATA ¹⁰ 500 GB 7200 rpm SATA ¹⁰ 501 GB 5400 rpm SATA ¹⁰

Primary M.2 Storage

1 TB PCIe[®] NVMe[™] M.2 SSD ¹⁰ 512 GB PCIe[®] NVMe[™] M.2 QLC Solid State Drive ¹⁰ 256 GB PCIe[®] NVMe[™] M.2 QLC Solid State Drive ¹⁰ 128 GB PCIe[®] NVMe[™] TLC Solid State Drive ¹⁰

Dual Storage

256 GB PCIe[®] NVMe[™] M.2 QLC Solid State Drive + 1TB 5400rpm SATA ¹⁰ 128 GB M.2 SATA-3 TLC Solid State Drive+ 1 TB 5400 rpm SATA ¹⁰



10. For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 11) is reserved for system recovery software.

MEMORY

Maximum Memory

32 GB DDR4-3200 MT/s SDRAM 11,12

Memory

32 GB DDR4-3200 MT/s SDRAM (2 X 16 GB) ^{11,12} 16 GB DDR4-3200 MT/s SDRAM (1 x 16 GB) ^{11,12} 16 GB DDR4-3200 MT/s SDRAM (2 x 8 GB) ^{11,12} 12 GB DDR4-3200 MT/s SDRAM (4 GB (1 x 4GB) and 8 GB (1 x 8 GB)) ^{11,12} 8 GB DDR4-3200 MT/s SDRAM (1 x 8 GB) ^{11,12} 8 GB DDR4-3200 MT/s SDRAM (2 x 4 GB) ^{11,12} 4 GB DDR4-3200 MT/s SDRAM (1 x 4 GB) ^{11,12}

Memory Slots

2 SODIMM (Ryzen 3/5/7 processors speed runs up to 3200 MT/s, Ryzen 3 3250U speed runs up to 2400 MT/s) ^{11,12} All slots are customer non-accessible / non-upgradeable Support Dual Channel Memory

11. All slots are non-accessible / non-upgradeable.

12. Due to the non-industry standard nature of some third-party memory modules, we recommend HP branded memory to ensure compatibility. If you mix memory speeds, the system will perform at the lower memory speed.

NETWORKING/COMMUNICATIONS

WLAN

Realtek RTL8822CE 802.11ac 2x2 Wi-Fi[®] + Bluetooth[®] 5.0 Wireless Card ¹³ Realtek RTL8821CE 802.11a/b/g/n/ac (1x1) Wi-Fi[®] with Bluetooth[®] 4.2 Wireless Card ¹³ Realtek RTL8852BE 802.11ax 2x2 Wi-Fi[®] + Bluetooth[®] 5.3 Wireless Card ¹⁴

Miracast

Compatible with Miracast-certified devices (For Win11)¹⁵

Ethernet

Integrated 10/100/1000 GbE ¹⁶

13. Wi-Fi supporting gigabit speeds (802.11ac) is achievable when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 160MHz channels

14. Wireless access point and internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 6 is backwards compatible with prior 802.11 specs. The specifications for Wi-Fi 6 (802.11ax) are draft and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the notebook to communicate with other 802.11ax devices

15. Miracast is a wireless technology your PC can use to project your screen to TVs, projectors, and streaming.



16. The term "10/100/1000" or "Gigabit" Ethernet indicates compatibility with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/s. For high-speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.

AUDIO/MULTIMEDIA

Audio

2 Integrated stereo speakers Integrated dual array microphone

Speaker Power

2W/4ohm

Camera

720p HD camera with Temporal Noise Reduction ⁷

7. HD content required to view HD images.

KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS

Keyboard

Full Size Textured island-style Keyboard and optional Backlit¹⁷

Pointing Device

Touchpad with multi-touch gesture support (PTP certified)

Function Keys

F1 - Open " How to get help in Windows 11" webpage

- F2 Brightness Down
- F3 Brightness Up
- F4 Display Switching
- F5 Blank
- F6 Mute
- F7 Volume Down
- F8 -Volume Up
- F9 Previous
- F10 Play/Pause
- F11 Next
- F12 Airplane mode

17. Backlit keyboard is an optional feature.



SOFTWARE AND SECURITY

Software

MYOffice MyHP HP QuickDrop¹⁸ HP Privacy Settings HP SUPPORT ASSISTANT ¹⁹ HP Audio Switch HP Connection Optimizer HP PC Hardware Diagnostics HP Smart Health ²⁰ HP Smart²¹

Manageability Features

Touchpoint Customizer for Consumer

NOTE: To enhance brightness, level go to the Intel[®] Graphics Command Center app, click on System and turn off the Display Power Savings function.

Security Management

McAfee Security (30 days free trial as default) ²² Express VPN (30 days free trial) LastPass password manager Discrete TPM 2.0 (select model) / Firmware TPM 2.0 ²³ Fingerprint reader ²⁴

18. HP Quick Drop requires Internet access and Windows 10 PC preinstalled with HP QuickDrop app and either an Android device (phone or tablet) running Android 7 or higher with the Android HP QuickDrop app, and /or an iOS device (phone or tablet) running iOS 12 or higher with the iOS HP QuickDrop app.

19. HP Support Assistant requires Windows and Internet access.

20. HP Smart Support automatically collects the telemetry necessary upon initial boot of the product to deliver device-level configuration data and health insights and is available preinstalled on select products, thru HP Factory Configuration Services; or it can be downloaded. For more information about how to enable HP Smart Support or for download, please visit http://www.hp.com/smart-support.

21. HP Smart Support automatically collects the telemetry necessary upon initial boot of the product to deliver device-level configuration data and health insights and is available preinstalled on select products, thru HP Factory Configuration Services; or it can be downloaded. For more information about how to enable HP Smart Support or for download, please visit http://www.hp.com/smart-support.

22. 30-day McAfee[®] LiveSafe[™] trial included. Internet access required and not included. Subscription required after expiration. See http://www.McAfee.com for more details.

23. Firmware TPM is version 2.0. Hardware TPM is v2.0.

24. HP Fingerprint Sensor is an optional feature and requires configuration at purchase.



QuickSpecs

Technical Specifications

POWER

Power Supply

HP Smart 65 W EM External AC power adapter ²⁵ HP Smart 45 W External AC power adapter ²⁵

Battery

HP Long Life 3-cell, 41 Wh Li-ion Polymer ^{26,27} Compliant with UL 1642 Standard

Power Cord 1M (3.28 feet) length power cord

Battery Life Up to 10 hours 15 mins ²⁸

Battery Weight 0.42 lb 0.19 kg

25. Availability may vary by country.

26. Battery is internal and not replaceable by customer. Serviceable by warranty.

27. Actual battery Watt-hours (Wh) will vary from design capacity. Battery capacity will naturally decrease with shelf life, time, usage, environment, temperature, system configuration, loaded apps, features, power management settings and other factors.

28. Windows MM18 battery life will vary depending on various factors including product model, configuration, loaded applications, features, use, wireless functionality, and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See www.bapco.com for additional details.

WEIGHTS & DIMENSIONS

Product Weight- 41 Whr²⁹ Starting at 3.84 lb Starting at 1.74 kg

Product Dimensions (W x D x H)

14.09 x 9.53 x 0.78 in 35.8 x 24.2 x 1.99 cm

29. Weight will vary by configuration. Does not include power adapter.



PORTS/SLOTS

Ports

2 SuperSpeed USB Type-A 5Gbps signaling rate (USB 3.2 Gen 1) ³⁰ 1 SuperSpeed USB Type-C[®] 5Gbps signaling rate (Supports data transfer only and does not support charging or external monitors) ³⁰ 1 HDMI v1.4b ³¹ 1 RJ-45 1 AC Power 1 Headphone/microphone combo jack

Expansion Slots

Support SD/SDHC/SDXC 1 Multi-format digital media reader

30. SuperSpeed USB 20Gbps is not available. 31.HDMI cable sold separately.



SERVICE AND SUPPORT

HP Services offers 1-year or 3-year limited warranties and 90 days software limited warranty options depending on country. Batteries have a default one year limited warranty except for Long Life batteries which will have same 1-year or 3-year limited warranty as the platform. Refer to http://www.hp.com/support/batterywarranty/ for additional battery information. On-site service and extended coverage is also available. HP Care Pack Services are optional extended service contracts that go beyond the standard limited warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: http://www.hp.com/go/cpc.³²

32. HP Care Packs are sold separately. Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. For details, visit http://www.hp.com/go/cpc. HP services are governed by the applicable HP terms and conditions of service provided or indicated to Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product.



SYSTEM UNIT

STSTEP UNIT	
Stand-Alone Power Requirements (AC Power)	Var
(AC Power) Nominal Operating Voltage	Yes
Average Operating Power	19V
Integrated graphics	4.5W@MM18 Vega7 Graphic Core
Discrete Graphics	
Max Operating Power	N/A UMA < 45W
Temperature	0MA < 43W
Operating	41°F to 95°F (5°C to 35° C)
Non-operating	-4°F to 140°F (-20°C to 60°C)
Relative Humidity	-4 F to 140 F (-20 C to 60 C)
Operating	10% to 90%
Non-operating	5% to 95%
Shock	
Operating	40 G, 2 ms duration, half-sine
Non-operating	240 G, 2 ms duration, half-sine
Random Vibration	
Operating	1.043 grams
Non-operating	3.5 grams
Altitude (unpressurized)	
Operating	-50 to 10,000 ft (-15m to 3,048 m)
Non-operating	-50 to 40,000 ft (-15m to 12,192 m)
Planned Industry Standard Certifications	
Regulatory Model Number	TPN-C151
UL	Yes
CSA	No
FCC Compliance	Yes
ENERGY STAR [®]	Yes ³³
EPEAT [®]	Yes, EPEAT [®] registered ³⁴
ICES	Yes
Australia /	Yes
NZ A-Tick Compliance	Yes
CCC	Yes
Japan VCCI Compliance	Yes
КС	Yes
BSMI	Yes
CE Marking Compliance	Yes
CU/EAC	Yes
CIT	N/A
Saudi Arabian Compliance (ICCP)	Yes
• • •	
SABS	Yes



33. Configurations of the HP 255 15.6 inch G9 that are ENERGY STAR[®] qualified are identified as HP 255 15.6 inch G9 ENERGY STAR on HP websites and on http://www.energystar.gov.

34.Based on US EPEAT[®] registration according to IEEE 1680.1-2018 EPEAT[®]. EPEAT[®] status varies by country. Visit www.epeat.net for more information.

DISPLAYS

NOTE: All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower.

1. Actual brightness will be lower with touchscreen or HP Sure View.

15.6 in FHD (1920 x 1080)	Outline Dimensions (W x H)	350.66*215.34(With PCBA) typ +/- 0.5		
Anti-Glare UWVA Low Blue	Active Area	344.16 x 193.59 typ		
Light sRGB NWBZ 300 eDP 1.4+PSR2 100 flat LCD Panel	Weight Diagonal Size Thickness	310g max		
		15.6"		
		2.45 typ /2.6 max		
	Interface	eDP1.4 Anti-Glare		
	Surface Treatment			
	Touch Enabled	No		
	Contrast Ratio	1000:1 typ		
	Refresh Rate	60Hz		
	Brightness	300nits typ		
	Pixel Resolution	1920 x 1080 (FHD) WLED RGB sRGB100% typ 8bits UWVA 89/89/89 Yes		
	Format Backlight Color Gamut Coverage Color Depth Viewing Angle Low Blue Light			
				Power Consumption (W, EBL@ 150nits max/ 200nits max)
Panel LCD 15.6-in FHD			Outline Dimensions (W x H)	350.96 * 216.65 (max. w/ PCB)
(1920x1080) Anti-Glare WLED			Active Area	344.16 x 193.59 typ
SVA 45percent cg 250nits eDP 1.2 w/o PSR NWBZ ultraslim	Weight	360g max		
I.2 W/UFJR NWD2 ULLIASLIII	Diagonal Size	15.6"		
	Thickness	3.2mm max		
	Interface	eDP1.2		
	mullac			

Surface Treatment

Touch Enabled

Contrast Ratio

Pixel Resolution

Refresh Rate

Brightness

Format

Backlight



Anti-Glare

300:1 typ

250nits typ

1920 x 1080 (FHD)

No

60Hz

WLED

RGB

QuickSpecs

Technical Specifications

	Color Gamut Coverage	NTSC45%
	Color Depth	6bit
	Viewing Angle	SVA 45/45/15/35
	Low Blue Light	No
	Power Consumption (W, EBL@ 150nits max/ 200nits max)	2.67W max / 3.33W max
15.6-in FHD (1920x1080) Anti-	Outline Dimensions (W x H)	350.96*216.75(max.)
ilare WLED UWVA 45percent cg	Active Area	344.16 x 193.59 (typ.)
250nits eDP 1.2 w/o PSR NWBZ slim	Weight	370g max.
	Diagonal Size	15.6"
	Thickness	3.2 max.
	Interface	eDP1.2
	Surface Treatment	Anti-Glare
	Touch Enabled	No
	Contrast Ratio	600:1 typ
	Refresh Rate	60Hz
	Brightness	250nits typ
	Pixel Resolution	1920 x 1080 (FHD)
	Format	WLED
	Backlight	RGB
	Color Gamut Coverage	NTSC45%
	Color Depth	6bits
	Viewing Angle	UWVA 85/85/85/85
	Low Blue Light	No
	Power Consumption (W, EBL@ 150nits max/ 200nits max)	2.75W max
5.6-in HD (1366x768) Anti- ilare WLED SVA 45percent cg	Outline Dimensions (W x H)	350.96 * 216.65 (max. w/ PCB)
50nits eDP 1.2 w/o PSR NWBZ	Active Area	344.23 x 193.54 typ
ıltraslim	Weight	360g max
	Diagonal Size	15.6"
	Thickness	3.2mm max
	Interface	eDP1.2
	Surface Treatment	Anti-Glare
	Touch Enabled	No
	Contrast Ratio	300:1 typ
	Refresh Rate	60Hz
	Brightness	250nits typ
	Pixel Resolution	1366 x 768 (HD)
	Format	WLED
	Format Backlight	WLED RGB NTSC45%

Not all configuration components are available in all regions/countries. c08017466 — DA16982 — Worldwide — Version 11 — April 24, 2024

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Color Depth Viewing Angle Low Blue Light Power Consumption (W, EBL@ 150nits max/ 200nits max) 6bits SVA 45/45/15/35 No 2.42W max / 2.98W max



STORAGE AND DRIVES

For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 11) is reserved for system recovery software.

Drive Weight	0.21 lbs (95 g)
Detetles and	-
Rotation speed	5400rpm
	up to 128MB
-	0.28 in (7 mm)
	2.75 in (69.85 mm)
-	ATA-8, SATA 3.0
Interface	600MB/s (Interface)
Maximum Sequential Read	Single Track: 1.5ms
	Agerage: 13ms
	Maximum: 32ms
-	1,953,525,168
-	0° to 60°C [case temp]
	ATA Security
	S.M.A.R.T., NCQ, Ultra DMA
Drive Weight	0.21 lbs (95 g)
-	5400rpm
•	up to 128MB
	N/A
	0.28 in (7 mm)
-	2.75 in (69.85 mm)
Interface	ATA-8, SATA 3.0
	600MB/s (Interface)
Seek Time	Single Track: 1.5ms
	Agerage: 13ms
	Maximum: 32ms
Logical Blocks	976,773,168
Operating Temperature	0° to 60°C [case temp]
Security Features	ATA Security
Features	S.M.A.R.T., NCQ, Ultra DMA
Drive Weight	0.21 lbs (95 g)
-	7200rpm
-	up to 128MB
	0.28 in (7 mm)
Width	2.75 in (69.85 mm)
	ATA-8, SATA 3.0
	600MB/s (Interface)
	Single Track: 1.5ms
	Agerage: 13ms
	Agelage. ISIIIS
	NAND Type Height Width Weight Interface Maximum Sequential Read Maximum Sequential Write Logical Blocks Operating Temperature Features Drive Weight Rotation speed Cache Buffer NAND Type/Size Height Width Interface Transfer Rate Seek Time Logical Blocks Operating Temperature Security Features Features Drive Weight Rotation speed Cache Buffer Height



	Logical Blocks	976,773,168
	Operating Temperature	0° to 60°C [case temp]
	Security Features	ATA Security
	Features	S.M.A.R.T., NCQ, Ultra DMA
SSD 128GB 2280 PCIe-3x2	Form Factor	M.2 2280
Three Layer Cell	Capacity	128GB
	NAND Type	TLC
	Height	0.09 in (2.3 mm)
	Width	0.87 in (22 mm)
	Interface	PCIe NVMe Gen3X4
	Maximum Sequential Read	up to 1600MB/s ±20%
	Maximum Sequential Write	up to 900MB/s ±20%
	Logical Blocks	250,069,680
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
	Features	Pyrite
SSD 1TB 2280 PCIe NVMe	Form Factor	M 2 2200
QLC		M.2 2280
4 -0	Capacity	1TB
	NAND Type	QLC
	Height	0.09 in (2.3 mm)
	Width	0.87 in (22 mm)
	Interface	PCIe NVMe
	Maximum Sequential Read	up to 2300MB/s ±20%
	Maximum Sequential Write	up to 2000MB/s ±20%
	Logical Blocks	2,000,409,264
	Operating Temperature Features	32° to 158°F (0° to 70°C) [ambient temp]
	reatures	Pyrite
SSD 256GB 2280 PCIe	Form Factor	M.2 2280
NVMe QLC	Capacity	256GB
	NAND Type	QLC
	Height	0.09 in (2.3 mm)
	Width	0.87 in (22 mm)
	Weight	0.02 lb (10 g)
	Interface	PCIe NVMe
	Maximum Sequential Read	up to 2300MB/s ±20%
	Maximum Sequential Write	up to 1280MB/s ±20%
	Logical Blocks	1,000,215,216
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
	Features	Pyrite



SSD 512GB 2280 PCIe	Form Factor	M.2 2280
NVMe QLC	Capacity	512GB
	NAND Type	QLC
	Height	0.09 in (2.3 mm)
	Width	0.87 in (22 mm)
	Interface	PCIe NVMe
	Maximum Sequential Read	up to 2300MB/s ±20%
	Maximum Sequential Write	up to 1400MB/s ±20%
	Logical Blocks	1,000,215,216
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
	Features	Pyrite

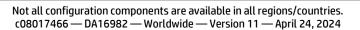


(III)

Technical Specifications

NETWORKING/COMMUNICATIONS

Realtek 802.11a/b/g/n/ac (1x1) Wi-Fi® and Bluetooth® 4.2 Wireless Card ¹		IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11n IEEE 802.11ac IEEE 802.11d IEEE 802.11e IEEE 802.11h IEEE 802.11h IEEE 802.11i IEEE 802.11k IEEE 802.11r IEEE 802.11v Wi. Ei contified medulos
	Interoperability Frequency Band	Wi-Fi certified modules •802.11b/g/n 2.402 – 2.482 GHz •802.11a/n/ac 4.9 – 4.95 GHz (Japan) 5.15 – 5.25 GHz 5.25 – 5.35 GHz 5.47 – 5.725 GHz 5.825 – 5.850 GHz
	Data Rates	 802.11b: 1, 2, 5.5, 11 Mbps 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11n: max 150Mbps 802.11ac : max 433.3Mbps
	Modulation	Direct Sequence Spread Spectrum BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM
	Security ³	 IEEE and WiFi certified 64 / 128 bit WEP encryption for a/b/g mode only AES-CCMP: 128 bit in hardware 802.1x authentication WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES. WPA2 certification WPA3 certification IEEE 802.11i WAPI
	Network Architecture Models Roaming Output Power ²	Ad-hoc (Peer to Peer) Infrastructure (Access Point Required) IEEE 802.11 compliant roaming between access points • 802.11b : +14dBm minimum • 802.11g : +12dBm minimum • 802.11a : +12dBm minimum • 802.11n HT20(2.4GHz) : +12dBm minimum • 802.11n HT40(2.4GHz) : +12dBm minimum • 802.11n HT20(5GHz) : +10dBm minimum • 802.11n HT40(5GHz) : +10dBm minimum • 802.11ac VHT80(5GHz) : +10dBm minimum
	Power Consumption	 Transmit mode 2.0 W Receive mode 1.6 W Idle mode (PSP) 180 mW (WLAN Associated)



		 Idle mode 50 mW (WLAN unassociated) Connected Standby 10mW Radio disabled 8 mW 		
	Power Management	ACPI and PCI Express compliant power management 802.11 compliant power saving mode		
	Receiver Sensitivity ⁴	802.11b, 1Mbps : -93.5dBm maximum 802.11b, 11Mbps : -84dBm maximum 802.11a/g, 6Mbps : -86dBm maximum 802.11a/g, 54Mbps : -72dBm maximum 802.11n, MCS07 : -67dBm maximum 802.11n, MCS15 : -64dBm maximum 802.11ac, MCS0 : -84dBm maximum 802.11ac, MCS9 : -59dBm maximum		
	Antenna type	High efficiency antenna. One embedded dual band 2.4/5 GHz antenna is provided to the card to support WLAN communications and Bluetooth communications		
	Form Factor	PCI-Express M.2 MiniCard		
	Dimensions	Туре 2230 : 2.3 x 22.0 x 30.0 mm		
	Weight	Туре 2230 : 2.8g		
	Operating Voltage	3.3v +/- 9%		
	Temperature	Operating Non-operating	14° to 158° F (–10° to 70° C) –40° to 176° F (–40° to 80° C)	
	Humidity	Operating Non-operating	10% to 90% (non-condensing) 5% to 95% (non-condensing)"	
	Altitude	Operating Non-operating	0 to 10,000 ft (3,048 m) 0 to 50,000 ft (15,240 m)	
	LED Activity	LED Amber – Radio OFF; LED OFF – Radio ON		
vitl	ith Bluetooth 4.0/4.1/4.2 Wireless Technology			
	Bluetooth Specification	4.0/4.1/4.2 Compliant		
	Free and the second	2402 to 2400 MU		

HP Integrated Module wit

Bluetooth Specification	4.0/4.1/4.2 Compliant	
Frequency Band	2402 to 2480 MHz	
Number of Available Channels	Legacy : 0~79 (1 MHz/CH) BLE : 0~39 (2 MHz/CH)	
Data Rates and Throughput	Legacy : 3 Mbps data rate; throughput up to 2.17 Mbps BLE : 1 Mbps data rate; throughput up to 0.2 Mbps Legacy : Synchronous Connection Oriented links up to 3, 64 kbps, voice channels Legacy : Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)	
Transmit Power	The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of + 4 dBm for BR and EDR.	
	Frequency Band Number of Available Channels Data Rates and Throughput	

1. Wi-Fi 5 is designed to support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 80MHz and higher channels. Wireless access point and internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 5 (802.11 ac) is backwards compatible with prior 802.11 specs.

2. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.

3. 1. Check latest software/driver release for updates on supported security features.

4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

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Realtek RTL8852BE 802.11ax 2x2 Wi-Fi® + Bluetooth® 5.3 Wireless Card (802.11ax 2x2, supporting gigabit data rate) ¹	Wireless LAN Standards	IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11n IEEE 802.11ac IEEE 802.11ax IEEE 802.11d IEEE 802.11e IEEE 802.11h IEEE 802.11h IEEE 802.11k IEEE 802.11r IEEE 802.11v
	Interoperability	Wi-Fi certified modules
	Frequency Band	•802.11b/g/n/ax 2.402 – 2.482 GHz •802.11a/n/ac/ax 4.9 – 4.95 GHz (Japan) 5.15 – 5.25 GHz 5.25 – 5.35 GHz 5.47 – 5.725 GHz 5.825 – 5.850 GHz
	Data Rates	•802.11b: 1, 2, 5.5, 11 Mbps •802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11n: max 300Mbps •802.11ac: max 866.7Mbps • 802.11ax: max 1201Mbps
	Modulation	Direct Sequence Spread Spectrum BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM, 1024QAM
	Security ³	 IEEE and WiFi certified 64 / 128 bit WEP encryption for a/b/g mode only AES-CCMP: 128 bit in hardware 802.1x authentication WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES. WPA2 certification WPA3 certification IEEE 802.11i WAPI
	Network Architecture	Ad-hoc (Peer to Peer)
	Models	Infrastructure (Access Point Required)
	Roaming Output Power ²	IEEE 802.11 compliant roaming between access points • 802.11b: +18.5dBm minimum • 802.11g: +17.5dBm minimum • 802.11a: +18.5dBm minimum • 802.11n HT20(2.4GHz): +15.5dBm minimum • 802.11n HT40(2.4GHz): +14.5dBm minimum • 802.11n HT20(5GHz): +15.5dBm minimum • 802.11n HT40(5GHz): +14.5dBm minimum • 802.11ac VHT80(5GHz): +11.5dBm minimum • 802.11ax HE40(2.4GHz): +10dBm minimum • 802.11ax HE80(5GHz): +10dBm minimum
	Power Consumption	•Transmit mode:2.5 W



QuickSpecs

Technical Specifications

		•Receive mode:2 W •Idle mode (PSP)180 mW(WLAN Associated) •Idle mode:50 mW(WLAN unassociated) •Connected Standby/Modern Standby: 10mW •Radio disabled: 8 mW		
	Power Management	•	ess compliant power management t power saving mode	
	Receiver Sensitivity ⁴	 •802.11b, 1Mbps : -93.5dBm maximum •802.11b, 11Mbps : -84dBm maximum •802.11a/g, 6Mbps : -86dBm maximum •802.11a/g, 54Mbps : -72dBm maximum •802.11n, MCS07 : -67dBm maximum •802.11n, MCS15 : -64dBm maximum •802.11ac, MCS0 : -84dBm maximum •802.11ac, MCS9 : -59dBm maximum •802.11ax, MCS11(HE40): -57dBm maximum •802.11ax, MCS11(HE80): -54dBm maximum 		
	Antenna type	High efficiency antenna with spatial diversity, mounted in the display enclosure Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications		
	Form Factor	PCI-Express M.2 MiniCard		
	Dimensions	1. Type 2230: 2.3 x 22.0 x 30.0 mm 2. Type 1216: 1.67 x 12.0 x 16.0 mm		
	Weight	1. Type 2230: 2.8g 2. Type 126: 1.3g		
	Operating Voltage	3.3v +/- 9%		
	Temperature	Operating Non-operating	14° to 158° F (–10° to 70° C) –40° to 176° F (–40° to 80° C)	
	Humidity	Operating Non-operating	10% to 90% (non-condensing) 5% to 95% (non-condensing)	
	Altitude	Operating Non-operating	0 to 10,000 ft (3,048 m) 0 to 50,000 ft (15,240 m)	
	LED Activity	LED Amber – Radio OFF LED Off – Radio ON		
vit	h Bluetooth 4.0/4.1/4.2/5.0	/5.1/5.2/5.3 Wire	less Technology	

HP Integrated Module w

Bluetooth Specification	4.0/4.1/4.2/5.0/5.1/5.2/5.3 Compliant
Frequency Band	2402 to 2480 MHz
Number of Available Channels	Legacy: 0~79 (1 MHz/CH) BLE: 0~39 (2 MHz/CH)
Data Rates and Throughput	Legacy: 3 Mbps data rate; throughput up to 2.17 Mbps BLE: 1 Mbps data rate; throughput up to 0.2 Mbps Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice channels Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)
Transmit Power	The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of + 4 dBm for BR and EDR.

1.Wi-Fi 6 is designed to support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 80MHz and higher channels. Wireless access point and Internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 6 (802.11ax) is backwards compatible with



prior 802.11 specs.

2. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.

3. Check latest software/driver release for updates on supported security features.

4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

Realtek RTL8822CE 802.11ac 2x2 Wi-Fi® + Bluetooth® 5.0 Wireless Card ¹	Wireless LAN Standards	IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11n IEEE 802.11ac IEEE 802.11d IEEE 802.11e IEEE 802.11h IEEE 802.11h IEEE 802.11k IEEE 802.11r IEEE 802.11v
	Interoperability	Wi-Fi certified modules
	Frequency Band	•802.11b/g/n 2.402 – 2.482 GHz •802.11a/n/ac 4.9 – 4.95 GHz (Japan) 5.15 – 5.25 GHz 5.25 – 5.35 GHz 5.47 – 5.725 GHz 5.825 – 5.850 GHz
	Data Rates	 802.11b: 1, 2, 5.5, 11 Mbps 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11n: max 300Mbps 802.11ac : max 866.7Mbps
	Modulation	Direct Sequence Spread Spectrum BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM
	Security3	 IEEE and WiFi certified 64 / 128 bit WEP encryption for a/b/g mode only AES-CCMP: 128 bit in hardware 802.1x authentication WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES. WPA2 certification WPA3 certification IEEE 802.11i WAPI
	Network Architecture Models	Ad-hoc (Peer to Peer) Infrastructure (Access Point Required)
	Roaming	IEEE 802.11 compliant roaming between access points
	Output Power2	 802.11b : +18.5dBm minimum 802.11g : +17.5dBm minimum 802.11a : +18.5dBm minimum 802.11n HT20(2.4GHz) : +15.5dBm minimum 802.11n HT40(2.4GHz) : +14.5dBm minimum 802.11n HT20(5GHz) : +15.5dBm minimum 802.11n HT40(5GHz) : +14.5dBm minimum



		• 802.11ac VHT8	0(5GHz) : +11.5dBm minimum
	Power Consumption	• Idle mode :50 n	1.6 W) 180 mW (WLAN Associated) nW (WLAN unassociated) ndby/Modern Standby: 10mW
	Power Management		ress compliant power management It power saving mode
	Receiver Sensitivity ⁴	802.11b, 11Mbp 802.11a/g, 6Mbp 802.11a/g, 54Mb 802.11n, MCS07 802.11n, MCS15 802.11ac, MCS0	: -93.5dBm maximum s : -84dBm maximum os : -86dBm maximum ops : -72dBm maximum : -67dBm maximum : -64dBm maximum : -84dBm maximum : -59dBm maximum
	Antenna type	enclosure Two embedded o	ntenna with spatial diversity, mounted in the display dual band 2.4/5 GHz antennas are provided to the card to IMO communications and Bluetooth communications
	Form Factor	PCI-Express M.2	MiniCard
	Dimensions		3 x 22.0 x 30.0 mm 57 x 12.0 x 16.0 mm
	Weight	1. Type 2230 : 2. 2. Type 126: 1.3g	-
	Operating Voltage	3.3v +/- 9%	
	Temperature	Operating Non-operating	14° to 158° F (–10° to 70° C) –40° to 176° F (–40° to 80° C)
	Humidity	Operating Non-operating	10% to 90% (non-condensing) 5% to 95% (non-condensing)
	Altitude	Operating Non-operating	0 to 10,000 ft (3,048 m) 0 to 50,000 ft (15,240 m)
	LED Activity	LED Amber – Rac LED Off – Radio (
HP Integrated Module with	h Bluetooth 4.0/4.1/4.2/5.0) Wireless Techno	logy
	Bluetooth Specification	4.0/4.1/4.2/5.0 (Compliant
	Frequency Band	2402 to 2480 MH	
	Number of Available Channels	Legacy : 0~79 (1 BLE : 0~39 (2 MH	
	Data Rates and Throughput	BLE : 1 Mbps data Legacy : Synchro channels Legacy : Asynchr	data rate; throughput up to 2.17 Mbps a rate; throughput up to 0.2 Mbps mous Connection Oriented links up to 3, 64 kbps, voice
		asymmetric (3-D	H5) or 864 kbps symmetric (3-EV5)

Transmit Power

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5) The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of + 4 dBm for BR and EDR.

1. Wi-Fi 5 is designed to support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 80MHz and higher channels. Wireless access point and internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 5 (802.11 ac) is backwards compatible with



prior 802.11 specs.

2. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.

3. Check latest software/driver release for updates on supported security features.

4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

Realtek RTK8111HSH 10/100/1000 Integrated NIC	Ethernet Features	10 Mbit/s operation (10BASE-T; IEEE 802.3i; IEEE 802.3 clauses 13-14) 100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21- 30) 1000 Mbit/s operation (1000BASE-T; IEEE 802.3ab; IEEE 8023 clauses 40) Auto-Negotiation (Automatic Speed Selection) Full Duplex Operation at all Speeds, Half Duplex operation at 10 and 100 Mbit/s
	Power Management	ACPI compliant – multiple power modes Situation-sensitive features reduce power consumption Advanced link down power saving for reducing link down power consumption
	Performance Features	TCP/IP/UDP Checksum Offload (configurable) Protocol Offload (ARP & NS) Large send offload and Giant send offload Receiving Side Scaling Jumbo Frame 9K
	Manageability	Wake-on-LAN from modern standby or sleep state (Magic Packet and Microsoft Wake-Up Frame); Wake-on-LAN from off (Magic Packet only) (MSC is supported on selected model) PXE 2.1 Remote Boot Statistics Gathering (SNMP MIB II, Ethernet-like MIB, Ethernet MIB (802.3x, clause 30)) Comprehensive diagnostic and configuration software suite Virtual Cable Doctor for Ethernet cable status



POWER

1. Actual battery Watt-hours (Wh) will vary from design capacity. Battery capacity will naturally decrease with shelf life, time, usage, environment, temperature, system configuration, loaded apps, features, power management settings and other factors.

HP 65W Smart AC	Dimensions (H x W x D)	90x51x28.5mm					
adapter	Weight Input	230g +/- 10g (Not including power cord. Power cord varies by country.) 100 to 240 VAC					
		Input Efficiency	88.0 % at 115 VAC and 89.0 % at 230VAC				
		Input frequency range	48 ~ 63 Hz Max. 1.7 A at 90 VAC				
		Input AC current					
	Output	Output power	65W				
		DC output	19.5V				
		Hold-up time	5ms at 115 Vac input				
		Output current limit	<11.0A Over voltage protection- 29V max automatic shutdown				
	Connector	4.5mm Barrel Type, 3 pin/g	rounded, mates with interchangeable cords				
	Environmental Design	Operating temperature Non-operating (storage)	32°F to 95°F (0° to 35°C) -4°F to 185°F (-20° to 85°C)				
		temperature					
		Altitude	0 to 16,400 ft (0 to 5,000m)				
		Humidity	20% to 95%				
	EMI and Safety	Storage Humidity Eg:	10% to 95%				
	Certifications	*CE Mark - full compliance with LVD and EMC directives * Worldwide safety standards - IEC60950-1 and/or IEC62 EN60950-1 and/or EN62368-1, UL60950-1 and/or UL62 SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55032 Class B, CISPR32 Class B, CCC, NOM-001 NYCE. * MTBF - over 200,000 hours at 25°C ambient condition.					
45 W AC adapter	Dimensions	95x40x26.5mm					
	Weight Input	200g +/- 10g (Not including 100 to 240 VAC	J power cord. Power cord varies by country.)				
		Input Efficiency	88.0 % at 115 VAC and 89.0 % at 230VAC				
		Input frequency range	48 ~ 63 Hz				
		Input AC current	Max. 1.4 A at 90 VA				
	Output	Output power	45W				
		DC output	19.5V				
		Hold-up time	5ms at 115 Vac input <8.0A Over voltage protection- 29V max				
	Connoctor	Output current limit	automatic shutdown				
	Connector Environmental Design	4.5mm Barrel Type, 3 pin/g Operating temperature	rounded, mates with interchangeable cords 32°F to 95°F (0°to 35°C)				
	Environmental Design	Operating temperature Non-operating (storage)	-4°F to 185°F (-20°to 85°C)				



Technical Specifications Altitude 1 to 16.400 ft (0 to 5.000m) Humidity 20% to 95% **Storage Humidity** 10% to 95% **EMI and Safety** Eq: Certifications *CE Mark - full compliance with LVD and EMC directives * Worldwide safety standards - IEC60950-1 and/or IEC62368-1. EN60950-1 and/or EN62368-1. UL60950-1 and/or UL62368-1. Class1. SELV: Agency approvals - C-UL-US, NORDICS, DENAN, EN55032 Class B, FCC Class B, CISPR32 Class B, CCC, NOM-001 NYCE. * MTBF - over 200,000 hours at 25°C ambient condition. Dimensions HP 65W EM Smart AC 102x55x30mm adapter 250g +/- 10g (Not including power cord. Power cord varies by country.) Weight Input 100 to 240 VAC **Input Efficiency** 88.0 % at 115 VAC and 89.0 % at 230VAC **Input frequency** 48~63 Hz range Max. 1.7 A at 90 VAC **Input AC current** Output 65W **Output power DC** output 19.5V Hold-up time 5ms at 115 Vac input <11.0A Over voltage protection- 29V max **Output current limit** automatic shutdown Connector 4.5mm Barrel Type, 3 pin/grounded, mates with interchangeable cords **Environmental Design** 32°Fto 95°F (0°to 35°C) Operating temperature Non-operating -4°Fto 185°F (-20°to 85°C) (storage) temperature Altitude 1 to 16,400 ft (0 to 5,000m) Humidity 20% to 95 **Storage Humidity** 10% to 95% **EMI and Safety** Eq: Certifications *CE Mark - full compliance with LVD and EMC directives * Worldwide safety standards - IEC60950-1 and/or IEC62368-1. EN60950-1 and/or EN62368-1, UL60950-1 and/or UL62368-1, Class1, SELV: Agency approvals - C-UL-US, NORDICS, DENAN, EN55032 Class B, FCC Class B, CISPR32 Class B, CCC, NOM-001 NYCE. * MTBF - over 200.000 hours at 25°C ambient condition.

HP 3-cell Long Life Li- Ion (41 Wh¹)	Dimensions (H x W x L) Weight	6.0 x 186.85 x 90.2 mm (0.23 x 7.29 x 3.52 inch) 0.175 Kg (0.385 lb)
	Cells/Type	3cell lithium-Ion Polymer cell 515974
	Energy	
	Voltage	11.34V/11.28V
	Amp-hour capacity	3.62Ah/3.635Ah
	Watt-hour capacity	41Wh
	Temperature	
	Operating (Charging)	32° to 113° F (0° to 45° C)
	Operating (Discharging)	14° to 122° F (-10° to 60° C)
	Fuel Gauge LED	N/A
	Warranty	1-year
	Optional Travel Battery Available	Νο



QuickSpecs

Technical Specifications

AUDIO

HD Stereo Codec	Realtek ALC3247
Audio I/O Ports	One Headset Combo-Jack connector support CTIA spec.
Internal Speaker Amplifier	2W class D stereo amplifier for the internal speaker only. External speakers must be powered.
Multi-streaming Capable	Playback multi-streaming can be enabled in the audio control panel to allow independent audio streams to be sent to/from the Combo jack or integrated speaker.
Sampling	4-channel DAC supports 16/20/24-bit PCM format for independent two stereo channel or 2.1 audio playback.
	4-channel ADC supports 16/20/24-bit PCM format for independent two stereo channel audio inputs.
	All DACs support 44.1k/48k/96k/192kHz sample rate.
	All ADCs support 44.1k/48k/96k/192kHz sample rate.
Wavetable Syntheses	Yes - Uses OS soft wavetable
Analog Audio	Yes.
# of Channels on Line-Out	0
Internal Speaker	Yes

FINGERPRINT READER

Sensor vendor	Elan eFSA80ST touch sensor
Sensor type	Capacitive
DPI resolution	
Scan area	
False Rejection Rate	FRR (False Reject Rate) / FAR (False Acceptance Rate): FRR ~ 2% @ 1:50K FAR
False Acceptance Rate	
Mobile Voltage Operation	Mobile Voltage Operation: 2.65V to 3.6V
Operating Temperature	Operating Temperature: 32° to 95° F (0° to 35° C)
Current Consumption	Current Consumption Image: 50mA peak
Image	
Low Latency Wait For	Low Latency Wait For Finger: <900 uA
Finger	
Capture Rate	Capture Rate: 20cm/sec
ESD Resistance	ESD Resistance: IEC 61000-4-2 (+15KV)
Detection Matrix	Detection Matrix: 508 dpi / 4x4mm sensor area

ENVIRONMENTAL DATA

Eco-Label Certifications &	This product has received	or is in the process of being c	ertified to the following approvals and may			
declarations	be labeled with one or more of these marks:					
	IT ECO declaration					
	US ENERGY STAR [®]					
	US Federal Energy Management Program (FEMP)					
			registration varies by country. See			
		t.net for registration status l				
			o IEEE 1680.1-2018 EPEAT [®] . Status varies			
		http://www.epeat.net for mo	re information.			
	• TCO- N/A					
		servation Program (CECP)				
		onmental Protection Adminis	Stration (SEPA)			
	 Taiwan Green Mai Korea Eco-label 	IK				
	 Japan PC Green la 	ahol*				
Sustainable Impact	• 5% post-consumer recyc					
Specifications	Low halogen	F				
	-	ted cushions are 100% susta	inably sourced and recyclable			
	_		nably sourced and recyclable			
	Bulk packaging available		,			
System Configuration			and Declared Noise Emissions data for the			
	-	on a "Typically Configured No				
Energy Consumption						
(in accordance with US						
ENERGY STAR [®] test						
ENERGY STAR® test method)	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz			
	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz			
method)	115VAC, 60Hz 5.34 W	230VAC, 50Hz 5.27 W	100VAC, 50Hz 5.31 W			
method) Normal Operation (Sort						
method) Normal Operation (Sort idle)						
method) Normal Operation (Sort idle) Normal Operation (Long	5.34 W	5.27 W	5.31 W			
method)NormalOperationidle)NormalOperationidle)	5.34 W 3.27 W	5.27 W 3.22 W	5.31 W 3.23 W			
method)NormalOperationidle)NormalOperationidle)Sleep	5.34 W 3.27 W 0.53 W	5.27 W 3.22 W 0.55 W	5.31 W 3.23 W 0.53 W			
method)NormalOperationidle)NormalOperationidle)Sleep	5.34 W 3.27 W 0.53 W	5.27 W 3.22 W 0.55 W	5.31 W 3.23 W 0.53 W			
method)NormalOperationidle)NormalOperationidle)Sleep	5.34 W 3.27 W 0.53 W 0.13 W NOTE: Energy efficiency data liste	5.27 W 3.22 W 0.55 W 0.16 W ed is for an ENERGY STAR® co	5.31 W 3.23 W 0.53 W 0.13 W mpliant product if offered within the model			
method)NormalOperationidle)NormalOperationidle)Sleep	5.34 W 3.27 W 0.53 W 0.13 W NOTE: Energy efficiency data liste	5.27 W 3.22 W 0.55 W 0.16 W ed is for an ENERGY STAR® co	5.31 W 3.23 W 0.53 W 0.13 W			
method)NormalOperationidle)NormalOperationidle)Sleep	5.34 W 3.27 W 0.53 W 0.13 W NOTE: Energy efficiency data liste family. HP computers mar	5.27 W 3.22 W 0.55 W 0.16 W ed is for an ENERGY STAR® co ked with the ENERGY STAR®	5.31 W 3.23 W 0.53 W 0.13 W mpliant product if offered within the model			
method)NormalOperationidle)NormalOperationidle)Sleep	5.34 W 3.27 W 0.53 W 0.13 W NOTE: Energy efficiency data liste family. HP computers mar Environmental Protection family does not offer ENE	5.27 W 3.22 W 0.55 W 0.16 W ed is for an ENERGY STAR® co ked with the ENERGY STAR® Agency (EPA) ENERGY STAR RGY STAR® compliant config	5.31 W 3.23 W 0.53 W 0.13 W mpliant product if offered within the model Logo are compliant with the applicable U.S. ® specifications for computers. If a model urations, then energy efficiency data listed			
method)NormalOperationidle)NormalOperationidle)Sleep	5.34 W 3.27 W 0.53 W 0.13 W NOTE: Energy efficiency data liste family. HP computers mar Environmental Protection family does not offer ENEL is for a typically configure	5.27 W 3.22 W 0.55 W 0.16 W ed is for an ENERGY STAR® co ked with the ENERGY STAR® Agency (EPA) ENERGY STAR RGY STAR® compliant config ed PC featuring a hard disk d	5.31 W 3.23 W 0.53 W 0.13 W mpliant product if offered within the model Logo are compliant with the applicable U.S. ® specifications for computers. If a model			
method)NormalOperationidle)NormalOperationidle)Sleep	5.34 W 3.27 W 0.53 W 0.13 W NOTE: Energy efficiency data liste family. HP computers mar Environmental Protection family does not offer ENE	5.27 W 3.22 W 0.55 W 0.16 W ed is for an ENERGY STAR® co ked with the ENERGY STAR® Agency (EPA) ENERGY STAR RGY STAR® compliant config ed PC featuring a hard disk d	5.31 W 3.23 W 0.53 W 0.13 W mpliant product if offered within the model Logo are compliant with the applicable U.S. ® specifications for computers. If a model urations, then energy efficiency data listed			
method) Normal Operation (Sort idle) Normal Operation (Long idle) Sleep Off	5.34 W 3.27 W 0.53 W 0.13 W NOTE: Energy efficiency data lister family. HP computers mar Environmental Protection family does not offer ENEL is for a typically configure Microsoft Windows® opera	5.27 W 3.22 W 0.55 W 0.16 W ed is for an ENERGY STAR® co ked with the ENERGY STAR® Agency (EPA) ENERGY STAR RGY STAR® compliant config ed PC featuring a hard disk d ating system.	5.31 W 3.23 W 0.53 W 0.13 W mpliant product if offered within the model Logo are compliant with the applicable U.S. ® specifications for computers. If a model urations, then energy efficiency data listed live, a high efficiency power supply, and a			
method) Normal Operation (Sort idle) Normal Operation (Long idle) Sleep Off	5.34 W 3.27 W 0.53 W 0.13 W NOTE: Energy efficiency data liste family. HP computers mar Environmental Protection family does not offer ENEL is for a typically configure	5.27 W 3.22 W 0.55 W 0.16 W ed is for an ENERGY STAR® co ked with the ENERGY STAR® Agency (EPA) ENERGY STAR RGY STAR® compliant config ed PC featuring a hard disk d	5.31 W 3.23 W 0.53 W 0.13 W mpliant product if offered within the model Logo are compliant with the applicable U.S. ® specifications for computers. If a model urations, then energy efficiency data listed			
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Technical Specifications

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	* NOTE: Heat attained for	-	is calculated t	ased on the	measure	ed watts, a	assuming	the service level is
Declared Noise Emissions		Sound Pow	/er			Sound F	Pressure	
(in accordance with ISO 7779 and ISO 9296)		(Lwad, bels	5)		(L _{pAm} , decibels)			
Typically Configured – Idle		3.2				2	5.7	
Fixed Disk – Random writes		3.3				20	6.5	
Optical Drive – Sequential reads		N/A				Ν	/A	
Longevity and Upgrading			raded, possibly ients contained		ts useful	life by sev	veral years	s. Upgradeable
	Spare parts a of production		e throughout t	ne warranty	period ar	nd or for u	p to "5" ye	ears after the end
Additional Information	dire • This Equ • This Drin • This www • Plas ISO	ctive - 201 5 HP product 5 product is 5 king Water 5 product is 6 w.epeat.net 5 tics parts w 1043.	t is designed to EE) Directive – in compliance and Toxic Enfo in compliance	comply wit 2002/96/EC with Californ rcement Act with the IEEE 5 grams use	h the Was ia Propos t of 1986 E 1680 (E ed in the p	ste Electric sition 65 (!). PEAT) star product are	cal and Ele State of Ca ndard at th e marked f	ectronic alifornia; Safe he Gold level, see per ISO11469 and
Packaging Materials	External:	PAPER/C	orrugated				295 g	
		PAPER/M	Iolded Pulp				141 g	
	Internal:	PLASTIC/	Polyethylene I	ow density -			10 g	
			Polypropylene	=			4 g	
	The plastic packaging material contains at least 0.0% recycled content.							
	The corrugated paper packaging materials contains at least 57.0% recycled content.							
RoHS Compliance	HP Inc. complies fully with materials regulations. We were among the first companies to extend the restrictions in the European Union (EU) Restriction of Hazardous Substances (RoHS) Directive to our products worldwide through the HP GSE. HP has contributed to the development of related legislation in Europe, as well as China, India, and Vietnam. We believe the RoHS directive and similar laws play an important role in promoting industry-wide elimination of substances of concern. We have supported the inclusion of additional substances—including PVC, BFRs, and certain phthalates—in future RoHS legislation that pertains to electrical and electronics products. We met our voluntary objective to achieve worldwide compliance with the new EU RoHS requirements for virtually all relevant products by July 2013, and we will continue to extend the scope of the commitment to include further restricted substances as regulations continue to evolve. To obtain a copy of the HP RoHS Compliance Statement, see HP RoHS position statement.							
Material Usage	to the	HP	General	Specific	ation	for	the	latory limits (refer Environment at pecifications.html



):
	 Asbestos Certain Azo Colorants Certain Brominated Flame Retardants – may not be used as flame retardants in plastics Cadmium Chlorinated Hydrocarbons Chlorinated Paraffins Bis(2-Ethylhexyl) phthalate (DEHP) Benzyl butyl phthalate (BBP) Dibutyl phthalate (DBP) Diisobutyl phthalate (DBP) Formaldehyde Halogenated Diphenyl Methanes Lead carbonates and sulfates Lead and Lead compounds Mercuric Oxide Batteries Nickel – finishes must not be used on the external surface designed to be frequently handled or carried by the user. Ozone Depleting Substances Polybrominated Biphenyl CiBBs) Polybrominated Biphenyl Oxides (PBBCs) Polychlorinated Biphenyl (PCB) Polychlorinated Terphenyls (PCT) Polyunyl Chloride (PVC) – except for wires and cables, and certain retail packaging has been voluntarily removed from most applications.
Packaging Usage	 Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO) HP follows these guidelines to decrease the environmental impact of product packaging: Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials. Eliminate the use of ozone-depleting substances (ODS) in packaging materials. Design packaging materials for ease of disassembly. Maximize the use of post-consumer recycled content materials in packaging materials. Use readily recyclable packaging materials such as paper and corrugated materials. Reduce size and weight of packages to improve transportation fuel efficiency. Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.
End-of-life Management	HP offers end-of-life HP product return and recycling programs in many geographic areas. To
and Recycling	recycle your product, please go to: http://www.hp.com/go/reuse-recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.
	The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: http://www.hp.com/go/recyclers . These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.



QuickSpecs

Technical Specifications

HP, I	Inc. Cor	porate	For more information about HP's commitment to the environment:
Environn Informat			Global Citizenship Report http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html Eco-label certifications http://www8.hp.com/us/en/hp-information/environment/ecolabels.html ISO 14001 certificates: http://h20195.www2.hp.com/V2/GetDocument.aspx?docname=c04755842 and http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf
footnote	S		 Percentage of ocean-bound plastic contained in each component varies by product Recycled plastic content percentage is based on the definition set in the IEEE 1680.1-2018 standard. External power supplies, WWAN modules, power cords, cables and peripherals excluded. 100% outer box packaging and corrugated cushions made from sustainably sourced certified and recycled fibers. Fiber cushions made from 100% recycled wood fiber and organic materials.

COUNTRY OF ORIGIN

China



QuickSpecs

Options and Accessories (sold separately and availability may vary by country)

Category	Description	Part Number	
Audio/Video	HP Wired USB-A Stereo Headset	428K6AA	
	HP Wired 3.5mm Stereo Headset	428K7AA	
	HP 500 BT Headset	53L34AA	
	HP 365 BT Speaker	567D3AA	
Cases	HP Prelude Backpack 15.6	1E7D6AA	
	HP Prelude Top Load 15.6	1E7D7AA 1X644AA 1X645AA 1X644AA 1X645AA 6KD07AA 6KD06AA 3E2U5AA 3E5F8AA	
	HP Prelude Pro Recycle Backpack		
	HP Prelude Pro Recycle Top Load		
	HP Prelude Pro Recycle Backpack		
	HP Prelude Pro Recycle Top Load		
	HP Executive 15.6 Backpack		
	HP Executive 15.6 Top Load		
	HP Renew Business 17.3" Backpack		
	HP Renew Business 15.6" Bag		
	HP Renew Business 17.3" Bag	3E2U6AA	
Hub	HP USB-C to USB-A Hub	Z6A00AA	
Adapter	HP USB 3.0 to Gigabit Adapter	N7P47AA	
	HP USB-C to RJ45 Adapter	V7W66AA N2Z63AA	
	HP USB-C to USB 3.0 Adapter		
	HP USB-C to RJ45 Adapter G2	4Z527AA	
	HP USB 3.0 to Gig RJ45 Adapter G2	4Z7Z7AA	
Keyboard/Combo	HP 975 USB+BT Dual-Mode Wireless Keyboard	3Z726AA	
	HP 655 Wireless Keyboard and Mouse Combo	4R009AA	
	HP 225 Wired Mouse and Keyboard Combo	286J4AA	
	HP 235 Wireless Mouse and Keyboard Combo	1Y4DOAA	
Mouse	HP USB Premium Wireless Mouse	1JR31AA	
	HP 435 Multi-Device Wireless Mouse	3B4Q5AA	
	HP Creator USB-A+Bluetooth 935 Wireless Mouse Black	1DOK8AA	
	HP USB-A+Bluetooth Travel Bluetooth Mouse	6SP30AA	
	HP 235 Slim Wireless Mouse	4E407AA	
Power	HP 65W Smart AC Adapter	Нбү89АА	
Commodity	HP USB DVD-Writer EXT ODD	F2B56AA	



Summary of Changes

Date of change	Version History		Description of change	
March 14, 2022	V1 to V2	Added	Battery Compliance in Power section; Environmental Data	
April 11, 2022	V2 to V3	Added	Reference for USB ports	
April 25, 2022	V3 to V4	Added	MIL-STD test in At a Glance section	
June 15, 2022	V4 to V5	Added	Added note in Manageability Feature	
August 5, 2022	V5 to V6	Updated	Eco-Label Certifications & declarations	
August 8, 2022	V6 to V7	Updated	Memory Slots	
October 20, 2022	V7 to V8	Updated	Bluetooth version	
March 6, 2023	V8 to V9	Updated	Storage and Drives section	
March 22, 2023	V9 to V10	Updated	USB Type C [®] description	
April 24, 2024	V10 to V11	Updated	Memory Section	

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